

Certificate

PROFIBUS Nutzerorganisation e.V. grants to

Texas Instruments
Haggertystr. 1, 85356 Freising, Germany

the Certificate No: **Z10659** for the PROFINET IO Device:

Model Name: AM3359 PROFINET(CC-B) evaluation kit
Revision: SW/FW: T 01.00.00; HW: 1
Identnumber: 0x0127; 0x0301
GSD: GSDML-V2.3-MOLEX_TI-AM335x-20131026.XML
DAP: DIM 1: Molex sample device, 0x10100000

This certificate confirms that the product has successfully passed the certification tests with the following PROFINET scope:

<input checked="" type="checkbox"/> Hardware	Auto_Negotiation, Auto_Polarity, Auto_Crossover
<input checked="" type="checkbox"/> Conformance Class B	RT_CLASS_1, RTA, LLDP, SNMP, MIB-II, LLDP-MIB

Test Report Number: PN244-1
Authorized Test Laboratory: SIEMENS AG, Fürth, Germany

The tests were executed in accordance with the following documents:
 "Test Specifications for PROFINET IO devices, Version 2.2.4 from December 2010" and
 "Test Cases for PN-Tester for PROFINET IO devices, Version 2.2.4.16.21".


This certificate is granted according to the document:
 "Framework for testing and certification of PROFIBUS and PROFINET products".

For all products that are placed in circulation by November 05, 2016 the certificate is valid for life.

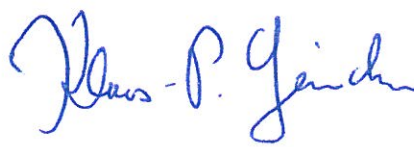


(Official in Charge)

Board of PROFIBUS Nutzerorganisation e. V.



(Karsten Schneider)

(K.-P. Lindner)

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